

# Ultra Low Mass Cooling for Fine Pixel Detectors

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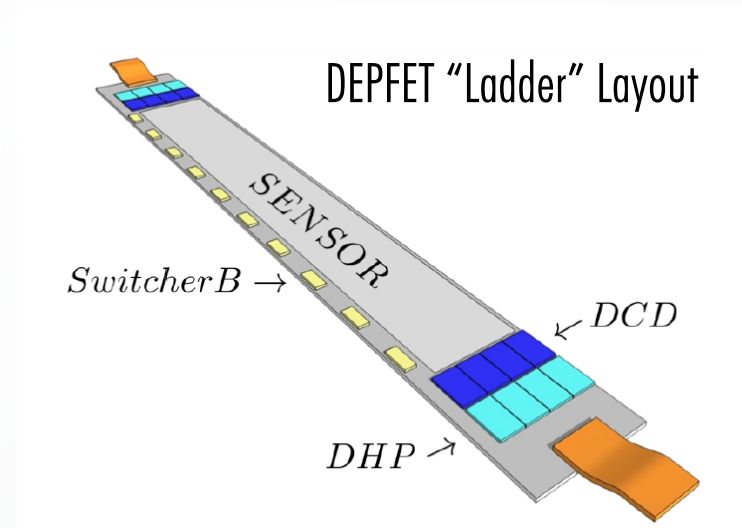
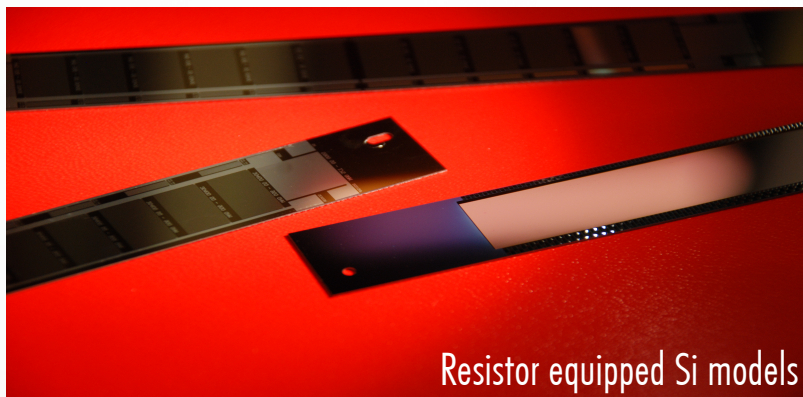


# Outline

- Motivation
- Thermal Dissipation studies:
  - Setup
  - Results
- Vibration and deformation studies
- Conclusions

# Motivation

- New tracker detectors require ultra-thin sensors to reduce multiple scattering:
  - e.g. DEpleted P-channel Field Effect Transistor (DEPFET)
  - Chosen technology for Belle II PXD
  - Candidate for ILD (among FPCCD, CMOS)

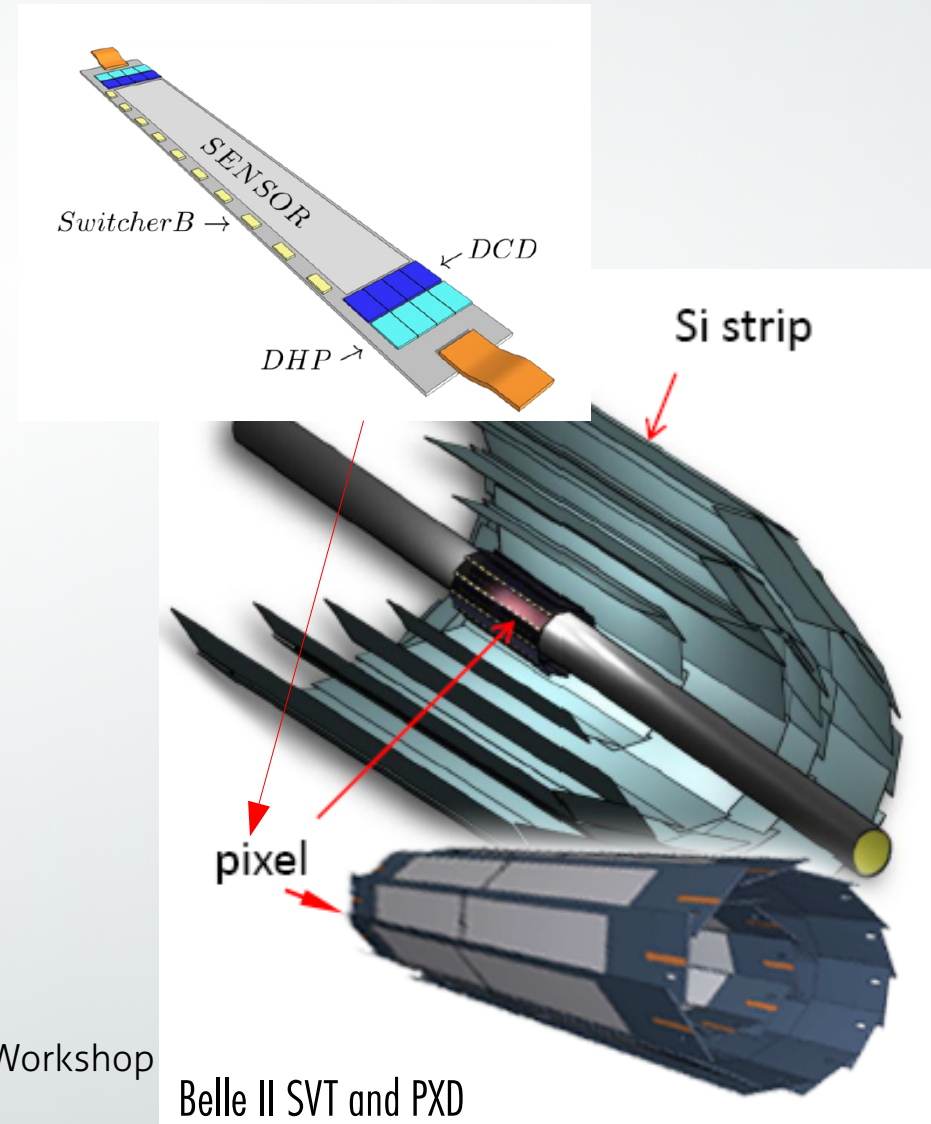


- Traditional conductive cooling defeats the whole purpose (high material budget)
  - The solution lies in low mass systems such as injection of gaseous coolants (convective cooling)
- Layout designed with the highest power dissipating elements in the end flanges

# Motivation

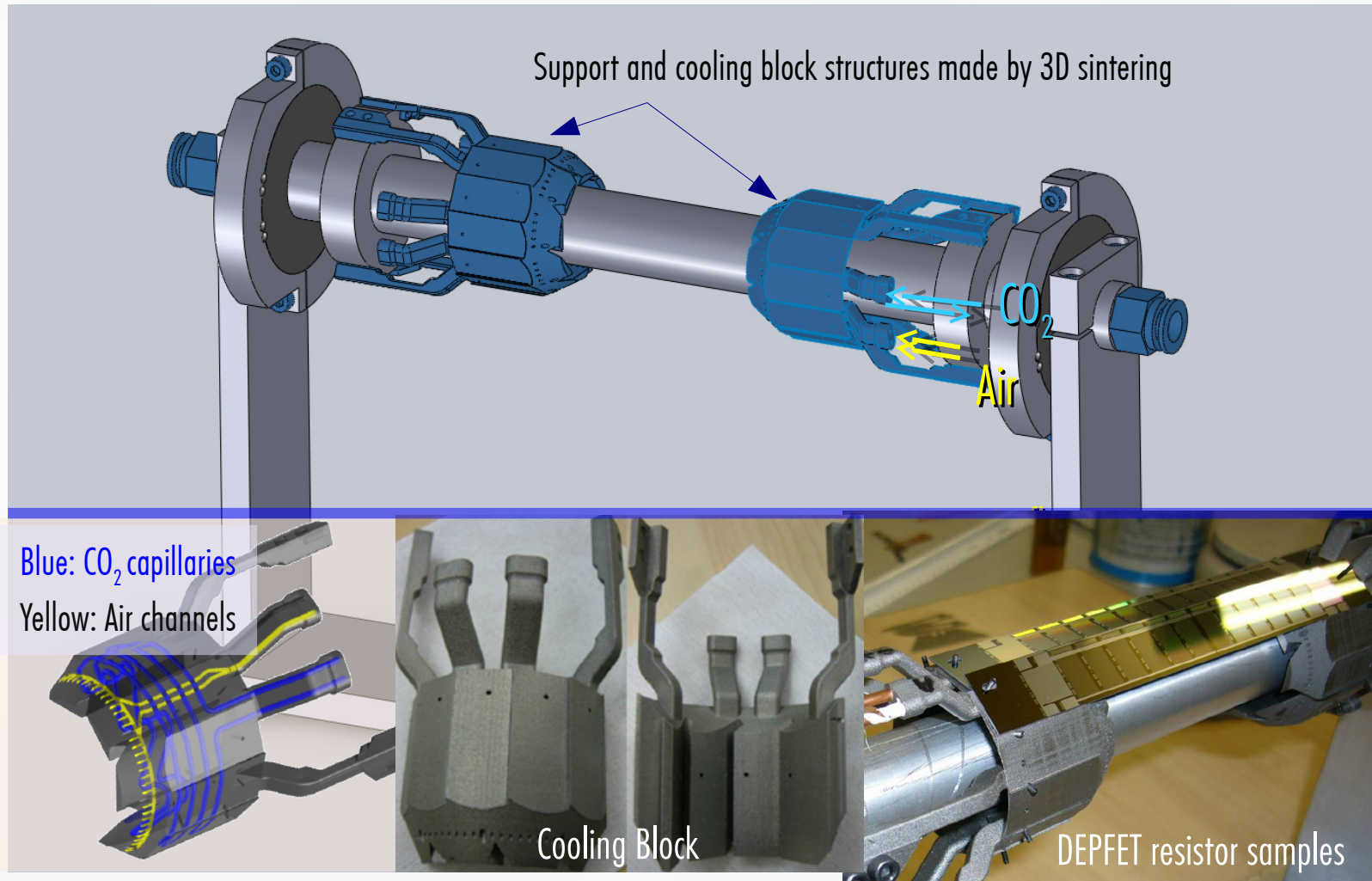
## Belle II Pixel detector (2 Layers)

- 75  $\mu\text{m}$  thin sensors in a 450  $\mu\text{m}$  support frame
- 12 Ladders in the outer layer and 8 Ladders in the inner layer
- Power dissipated
  - 1 Watt in the sensor region
  - 1 W in the switchers
  - 8 W in each FEE end
- Angular acceptance ranges from  $17^\circ$  to  $150^\circ$
- The support structure is designed allowing convective cooling in the sensor area and  $\text{CO}_2$  active cooling out of the acceptance region

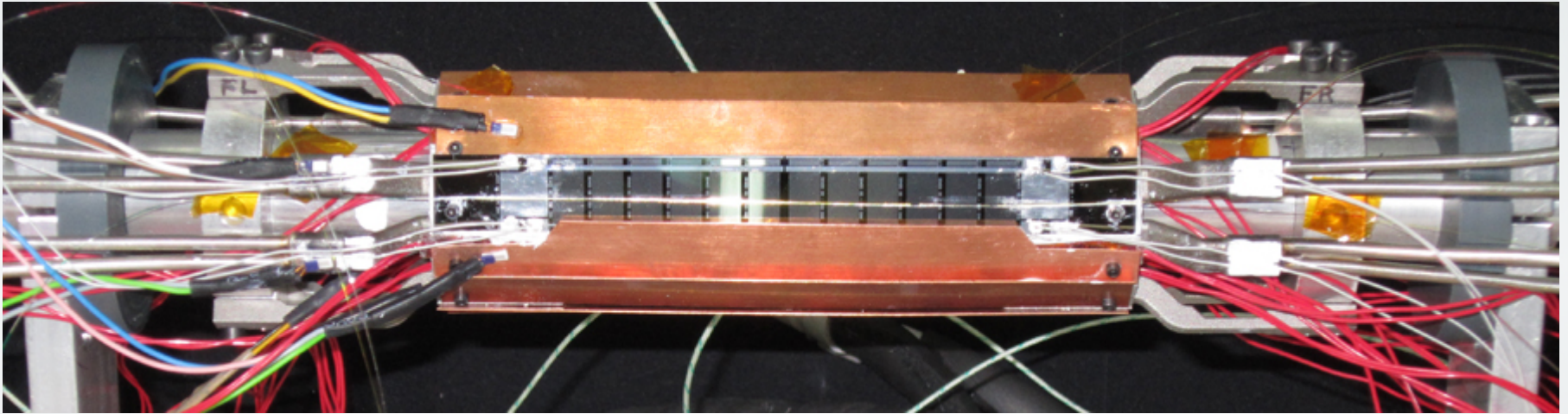




# Support/Cooling Hybrid Structure



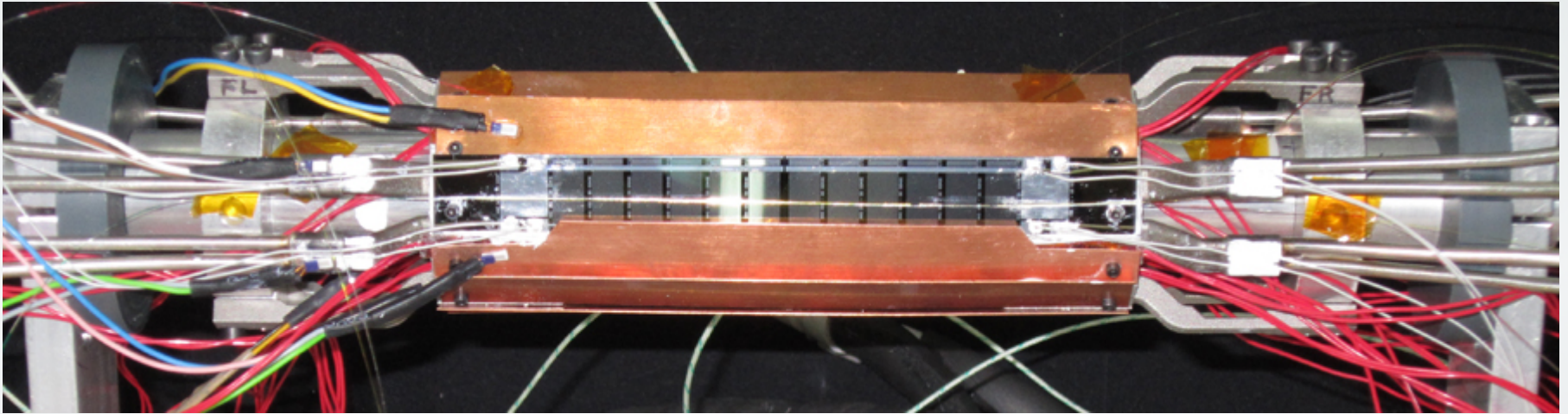
# Experimental Setup



- Valencia PXD Mockup
  - Stainless Steel Cooling Blocks
  - Enclosed with copper foil ladders equipped with resistive heaters in the end flanges for both layers
  - A single Si thinned detector with printed Al resistors

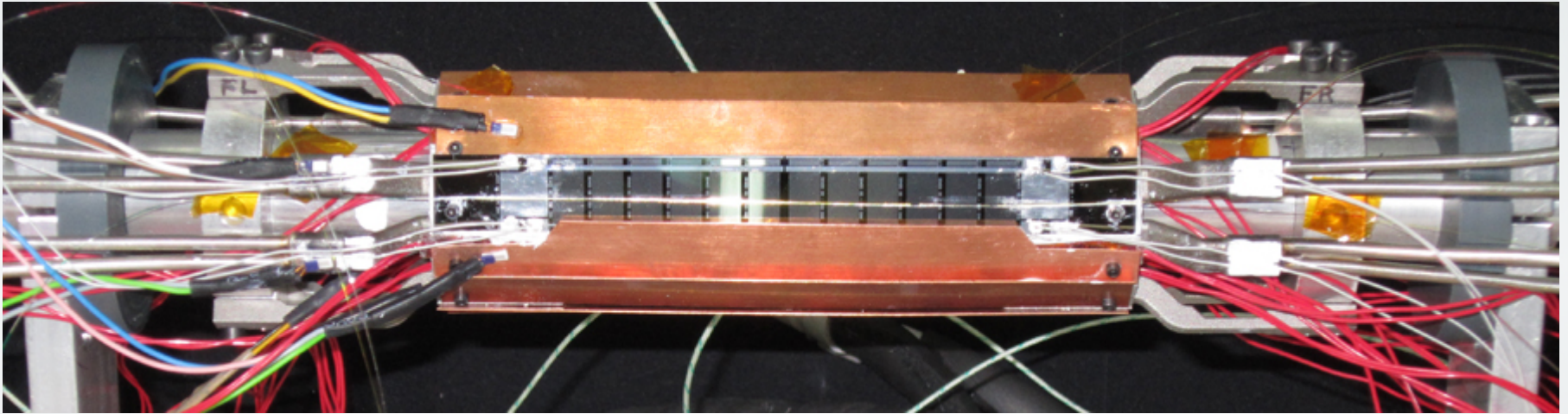


# Experimental Setup



- Cooling:
  - Liquid CO<sub>2</sub> circulated in the Cooling Blocks at -35°C
  - Injection of cooled (~0°C) N<sub>2</sub> Gas towards the sensor region at 3 bar and 15 L/min flow rate
  - Beam Pipe kept at 15°C with a composite liquid coolant.

# Experimental Setup

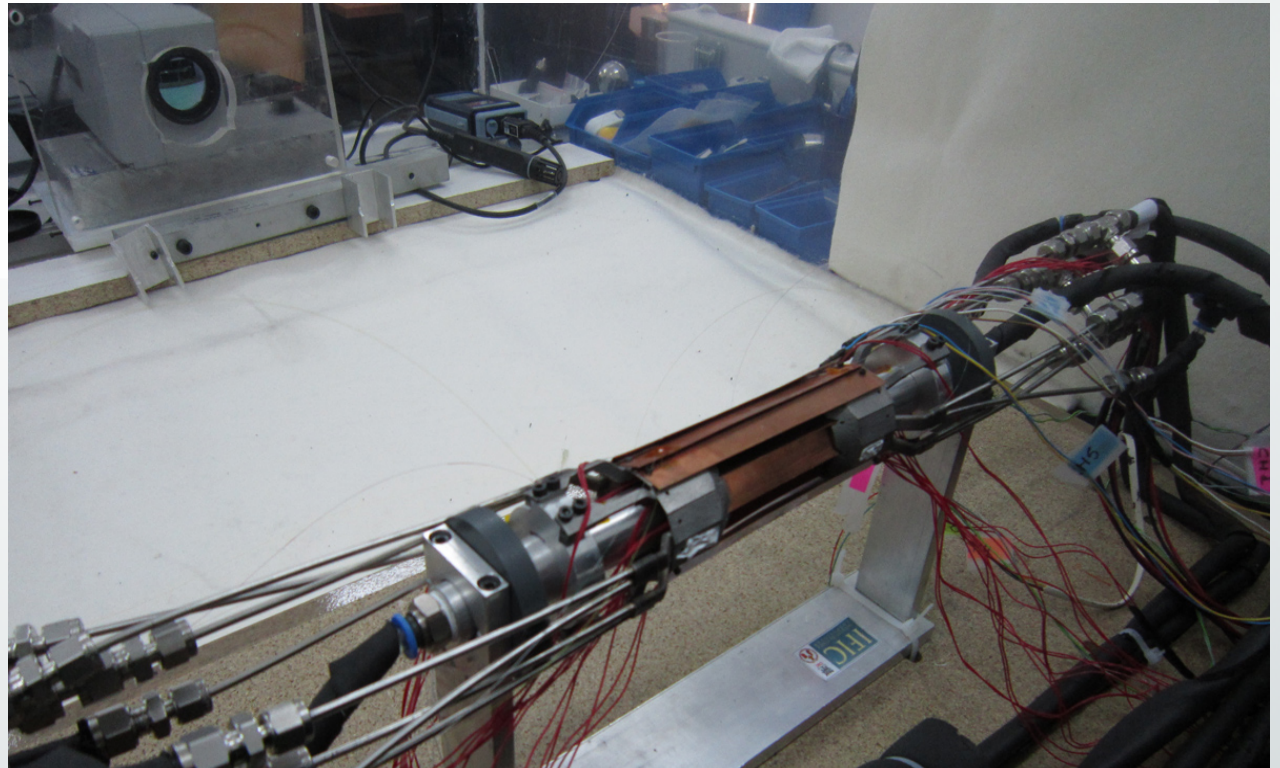


- Measurement equipment:
  - Infrared Thermal Imaging Camera
  - Fiber Bragg Grating (FBG) temperature and humidity sensors
  - Pt100 probes



# Experimental Setup

- The whole mockup is enclosed in a sealed methacrylate box, which allows control of the atmosphere
  - Humidity must be kept very low to avoid frosting, which affects the emissivity and complicates infrared measurements.
  - Environment temperature is stable inside the box



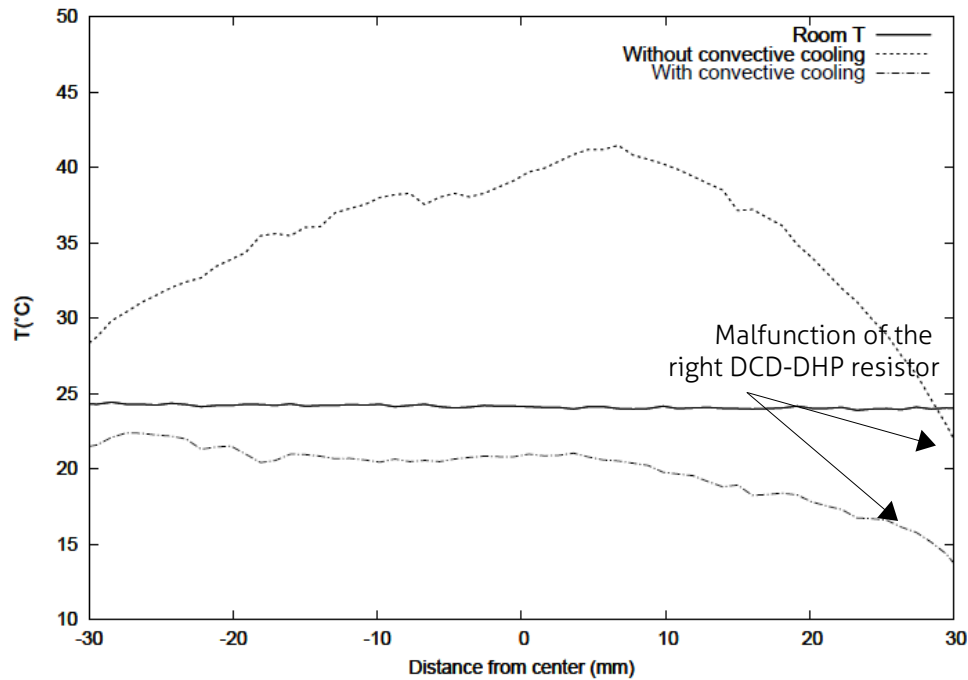
# Results



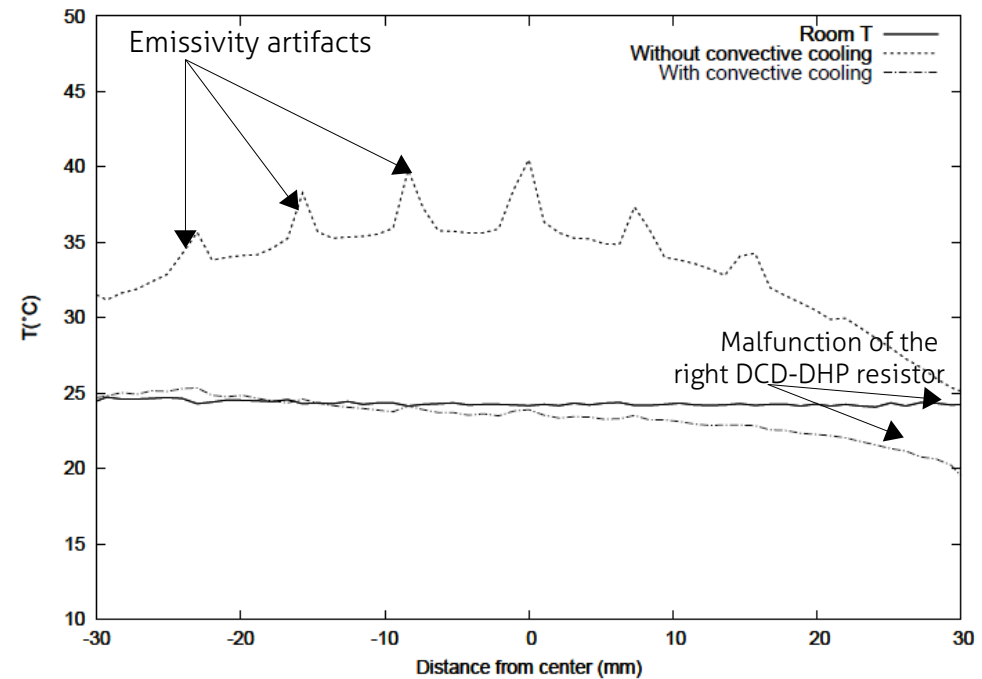
	Sensor T	Ambient T = 25°C
Without convective cooling	$T_{MAX} \approx 40^{\circ}\text{C}$	$\Delta T \approx 15^{\circ}\text{C}$
With convective cooling	$T_{MAX} \approx 25^{\circ}\text{C}$	$\Delta T \approx 5^{\circ}\text{C}$

# Results

Sensor surface

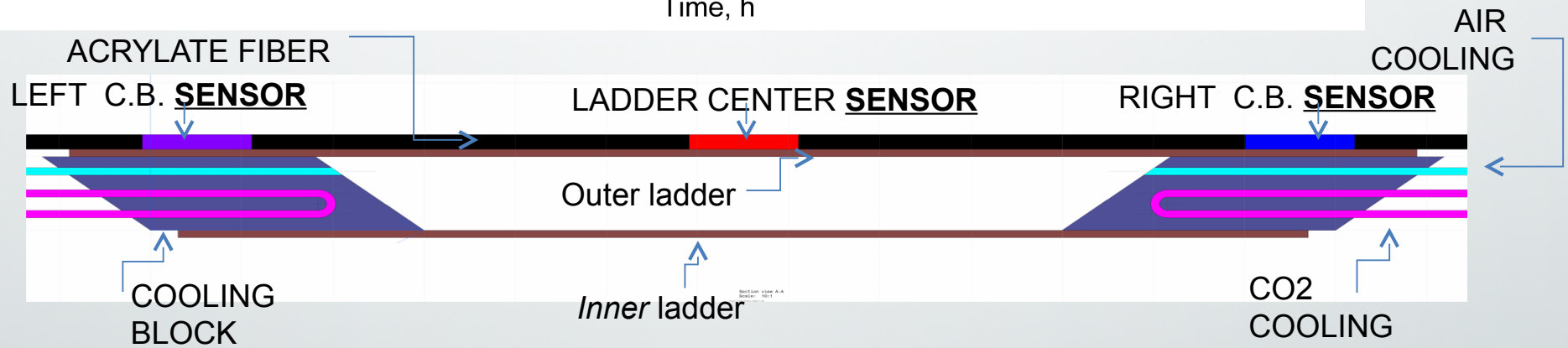
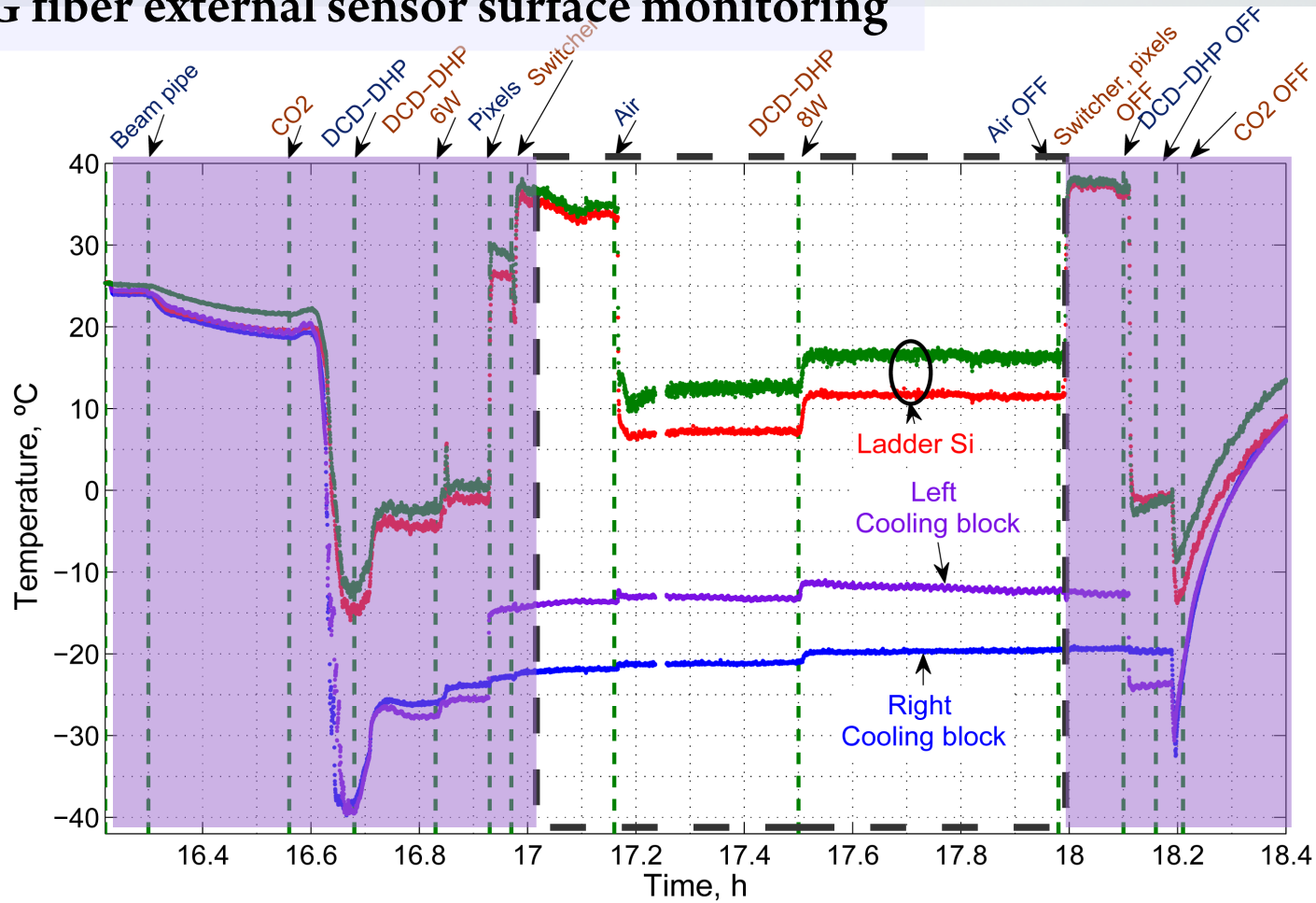


Switcher surface



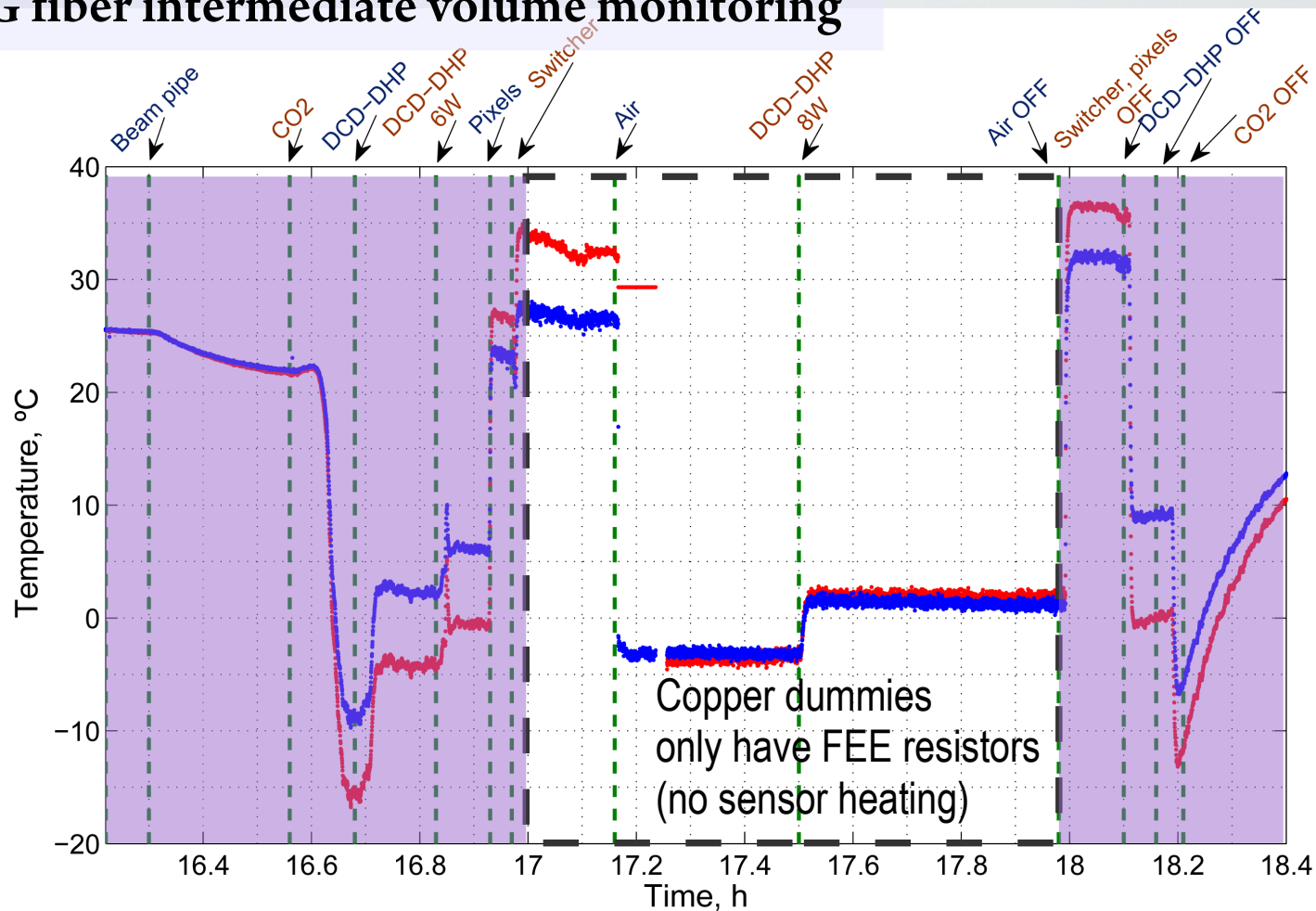
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# FBG fiber external sensor surface monitoring

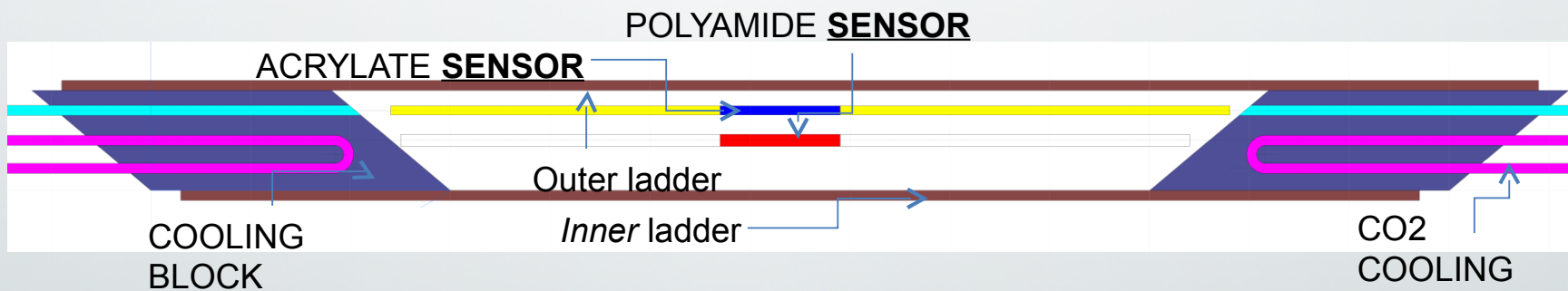




# FBG fiber intermediate volume monitoring

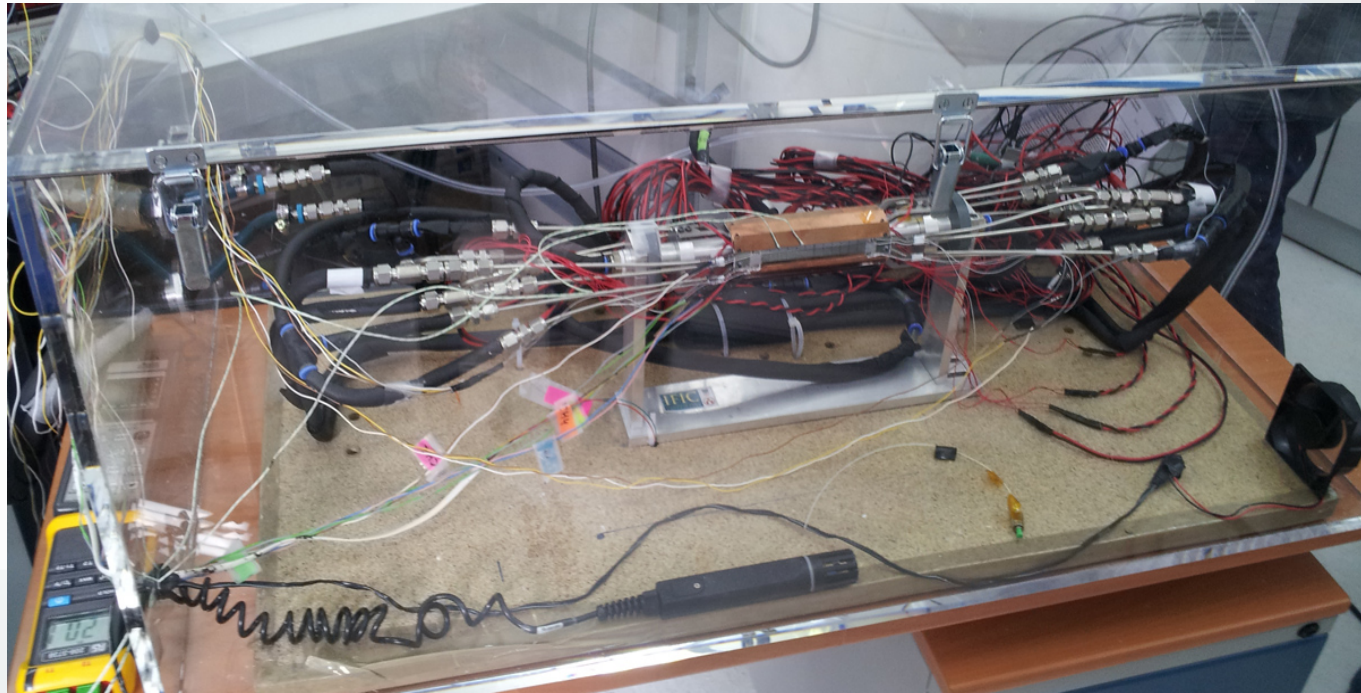


AIR COOLING

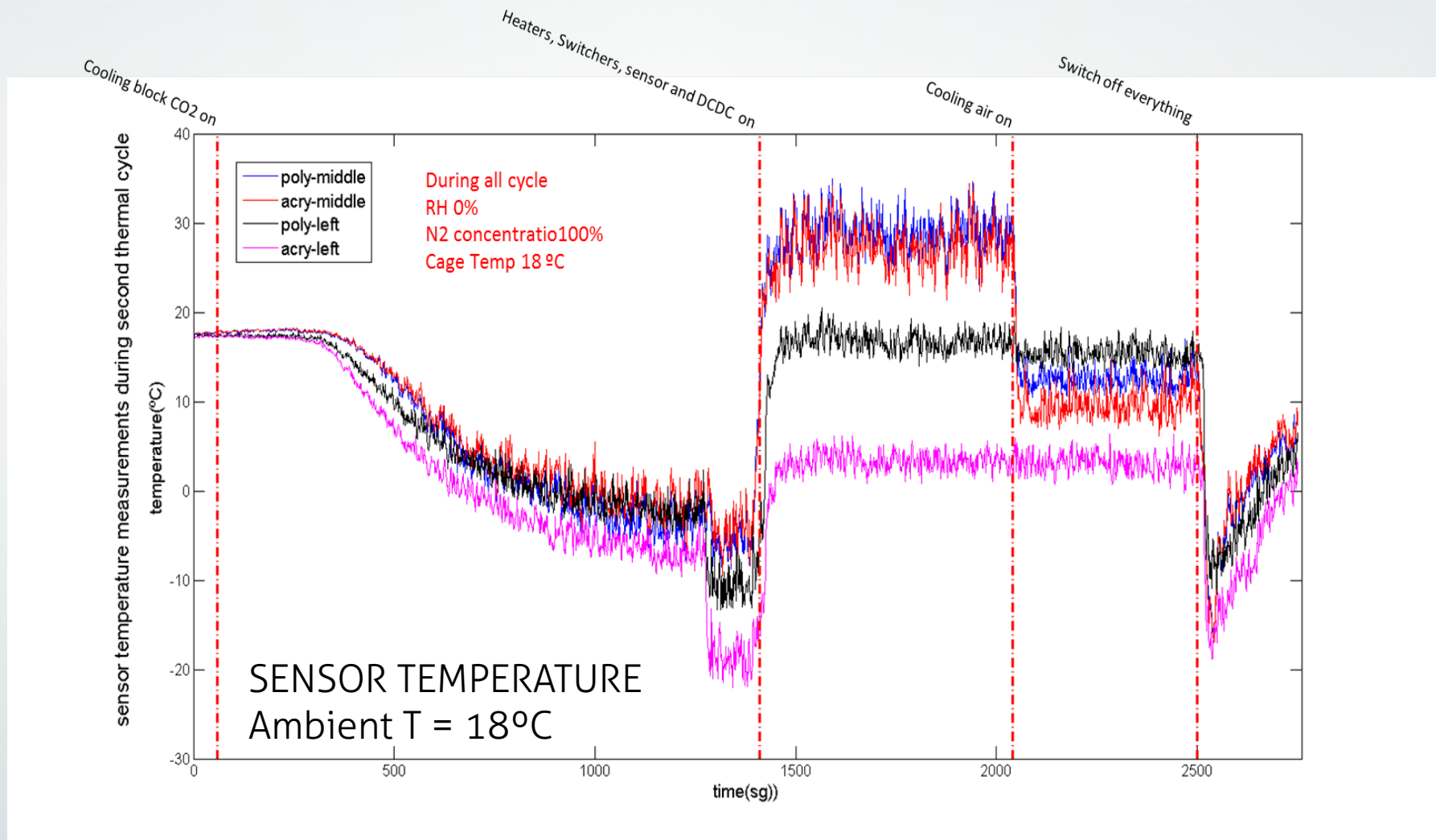


# Different Environment Temperatures

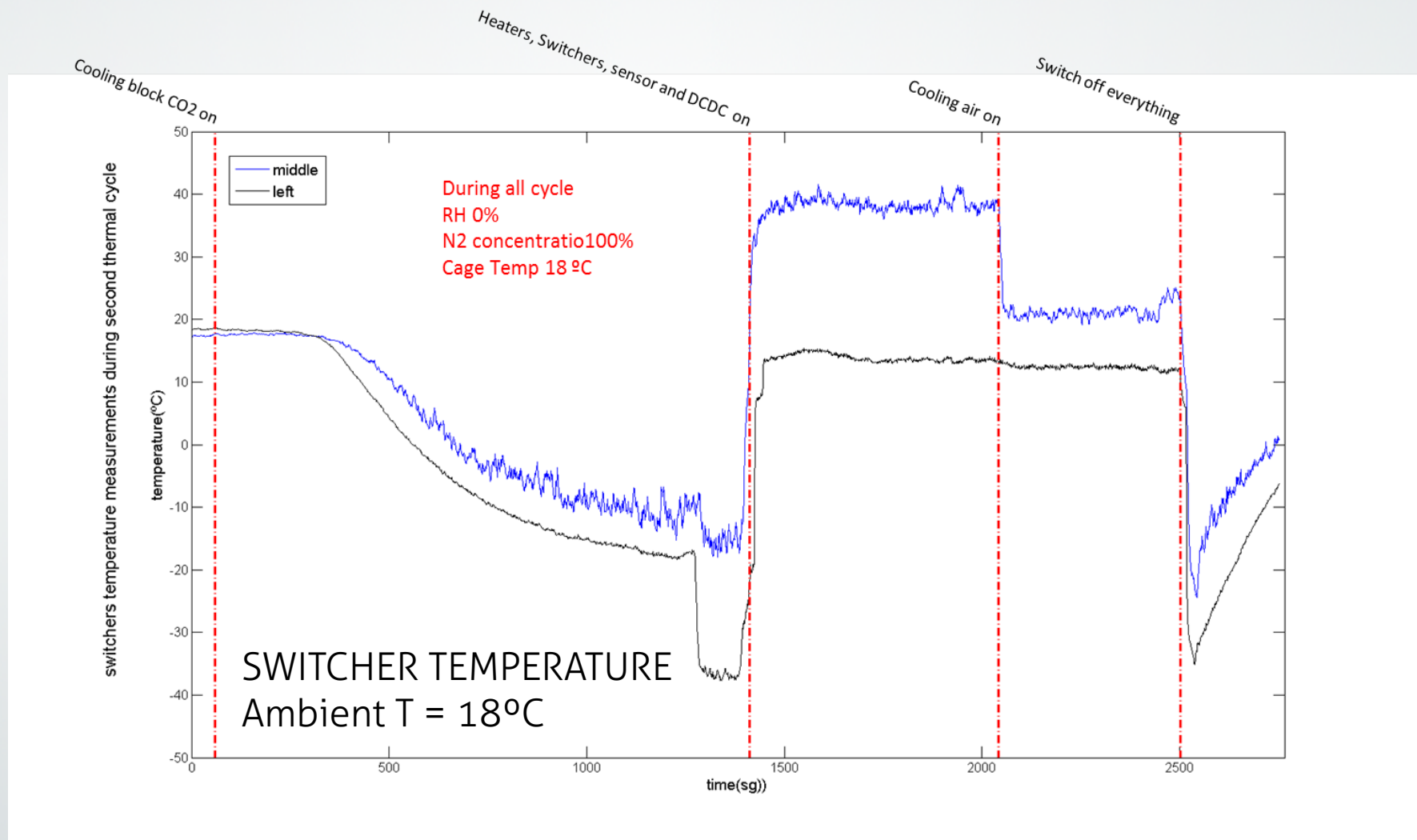
- The whole mockup was moved to a smaller box, thermally isolated
- Cooling of the environment temperature
  - Pure N<sub>2</sub> gas atmosphere
- No thermal imaging due to space constraints
  - FBG cross referenced with Pt100s



# Results



# Results





# Results

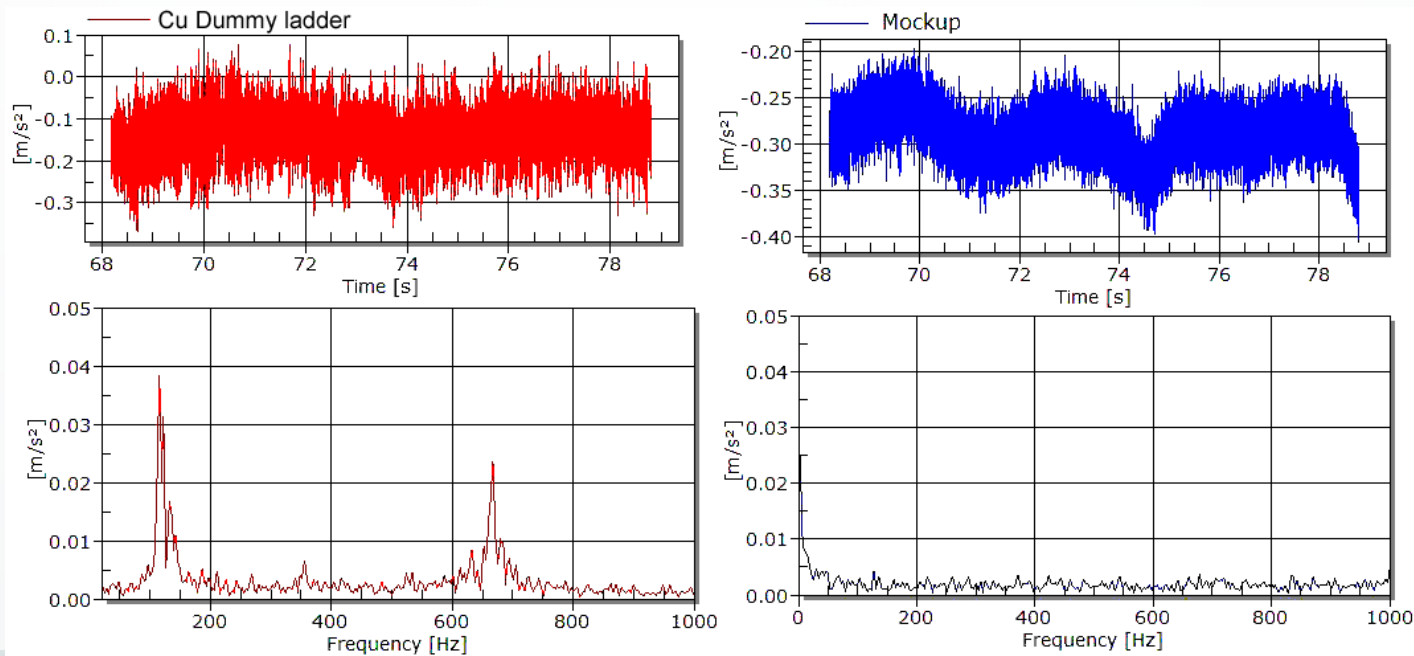
- Sensor temperature with convective cooling depends on the ambient temperature

Ambient T ( $\pm 2$ °C)	No air cooling T( $\pm 2$ °C)		Air cooling T( $\pm 2$ °C)		$T_{\text{hot}} - T_{\text{cool}}$ ( $\pm 3$ °C)	
	Sensor	Switcher	Sensor	Switcher	Sensor	Switcher
25	35	37	20	25	15	12
18	28	39	10	21	18	18
13	24	36	7	18	17	18

- Cooled N<sub>2</sub> gas at 3 bar and 15 L/min flow rate
- T gradient along the ladder  $\sim 5$ °C

# Vibration Studies

- Air injection could cause vibrations in the ladder which may compromise the physical integrity of the thin sensors.
- We measured the displacement and vibrations using capacitive distance sensors and accelerometers.
  - The whole mockup was studied to isolate the effect of the gas injection



# Vibration Studies

- No vibrations were observed below 2kHz (sensor cutoff) with the cooling requirements (3 bar in the entrance pipes).
  - A ~400Hz peak appears at p=4 bar and above, amplitude 0.7 $\mu$ m rms



# Conclusions

- Cooling of a working fine pixel sensor works properly
  - Combining contact and convective cooling
- No vibrations observed at the pressures studied for cooling



# Relevance for ILD

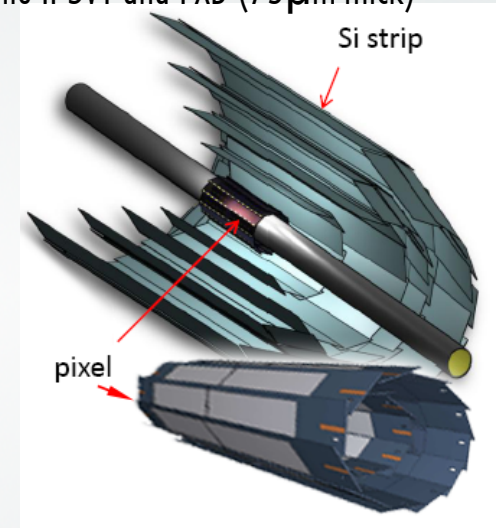
## ■ Belle II

- ▶ 360 W entire pixel detector
- ▶ Convective cooling in the thin sensor area
- ▶ CO<sub>2</sub> active cooling out of the acceptance

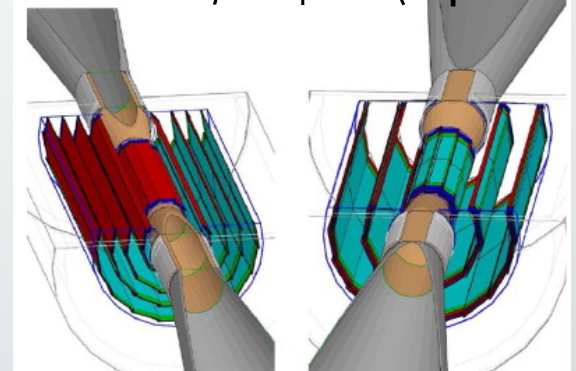
## ■ ILD

- ▶ Naively ~900 to ~1080 W total
- ▶ ~4 to 5 W with power pulsing (ideal 1:200 duty cycle)
- ▶ No active cooling due to angular acceptance requirements
  - **Convective cooling (performance demonstrated in Belle II)**

Belle II SVT and PXD (75 $\mu$ m-thick)



ILD tracker layout options (50 $\mu$ m-thick)



Single sided  
5 Layers

Double sided  
3 Layers

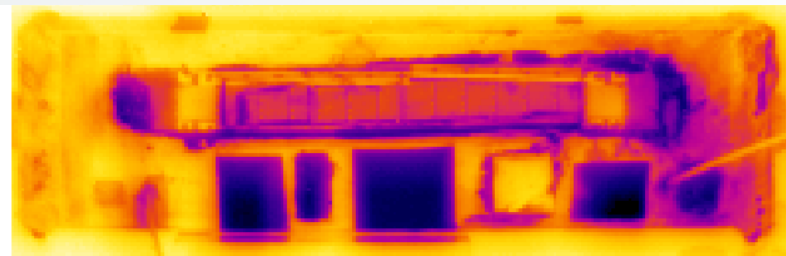
**Thank you very much**

# Backup

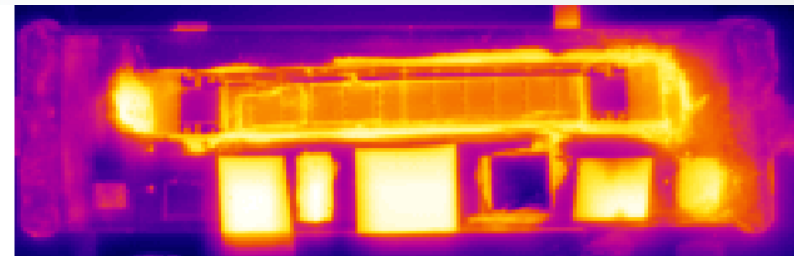


# Emissivity calibration

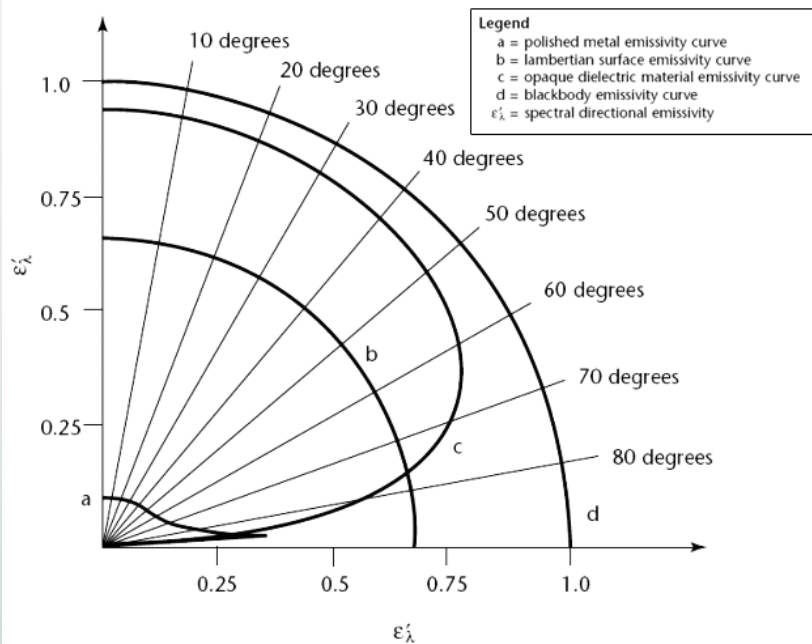
Variable temperature box with different surface samples, measured normal incidence emissivities at different temperatures and found no significant behavior with temperature. Emissivity corrections are done by adjusting  $\varepsilon$  until temperature is consistent with Pt100/thermocouple measurements



-20°C



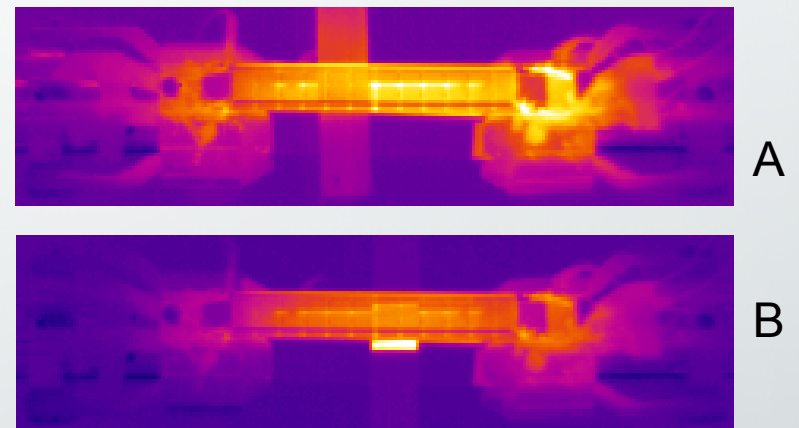
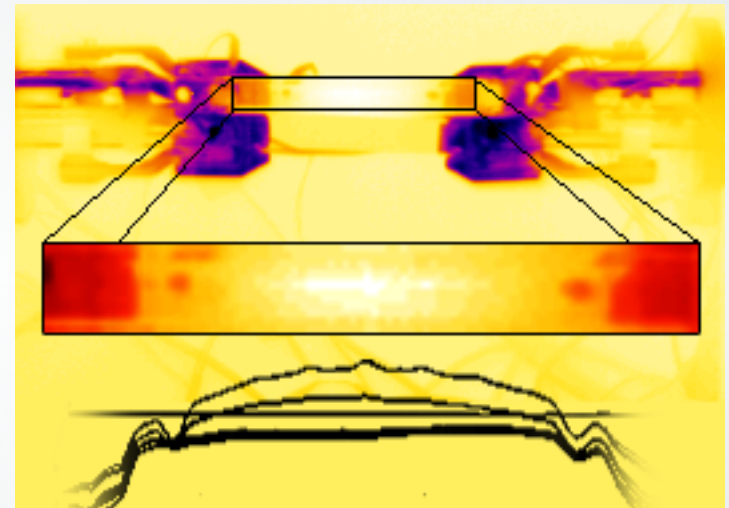
95°C



Material	Normal Emissivity
Sensor surface	0,67±0,03
DCD-DHP	0,34±0,04
Tipp-ex	0,97±0,09
Al	0,26±0,12
Cu	0,22±0,12
Thermal paste	0,88±0,09
Kapton Tape	0,99±0,10

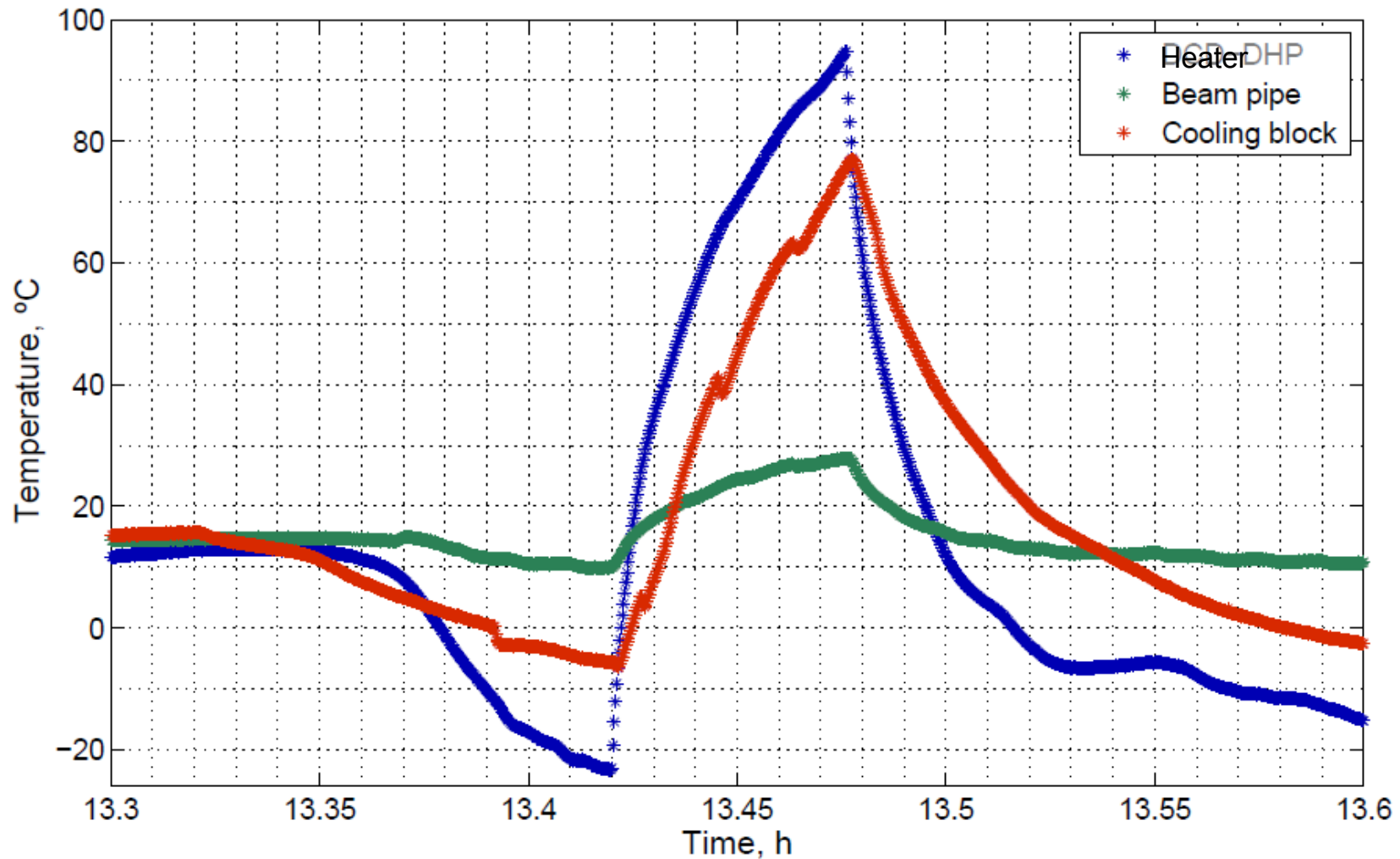
# Transparency of the Si sensor

- Peculiar shape of the T profile revealed infrared transparency of the ultrathin sensor layer.
- Measurements at the switchers (thicker) avoid this effect, we can still trust sensor surface values away from the CB regions.
- Fig. *a* shows opaque slide behind sensor, while *b* shows reflective slide, observe the pattern along the sensor surface change accordingly in each case.



# CO<sub>2</sub> system failure

(as seen by the beam pipe sensors)





# Vibrations & Deformation

## Experimental setup

- Fully enclosed volume with Cu dummies and Si resistive sample in outer layer.
- Probes



– Contact accelerometers (Piezotronics PCB 352A24)



– Capacitive sensor (Micro-Epsilon Capa NCDT 6100)

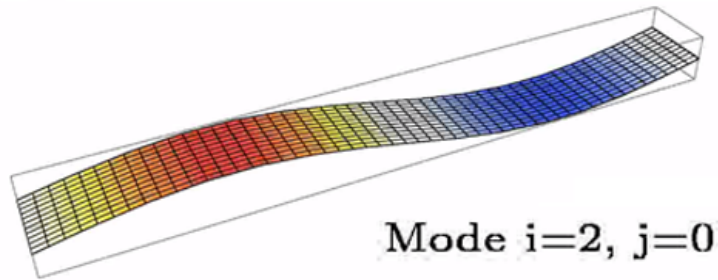
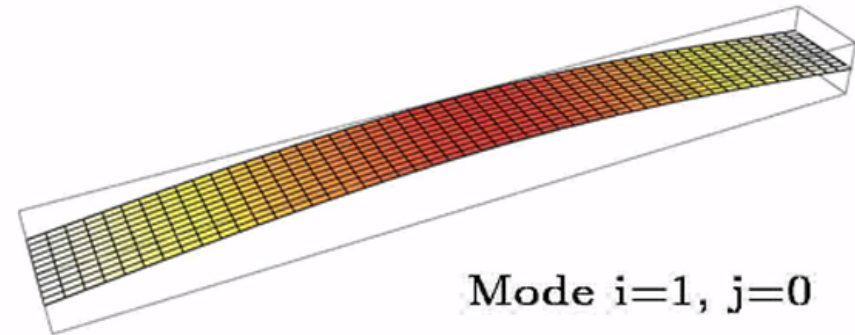
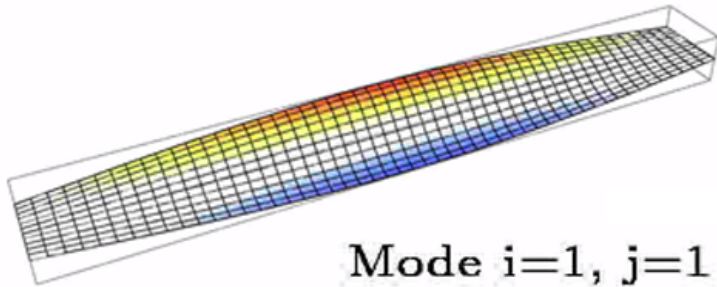
Sensitivities:

Capacitive sensor:  $0.15\mu\text{m}$

Accelerometers:  $0.002\text{ m/s}^2$

# Vibrational modes

Vibrations of a DEPFET ladder



Courtesy of M. Nebot

$$L_x / L_y \simeq 9$$

$$\omega_{ij} = \pi \sqrt{\frac{\tau}{\rho}} \sqrt{\frac{i^2}{L_x^2} + \frac{j^2}{L_y^2}}$$

$$\eta_{ij}(x, y) = \sin\left(\frac{i \pi x}{L_x}\right) \cos\left(\frac{j \pi y}{L_y}\right)$$

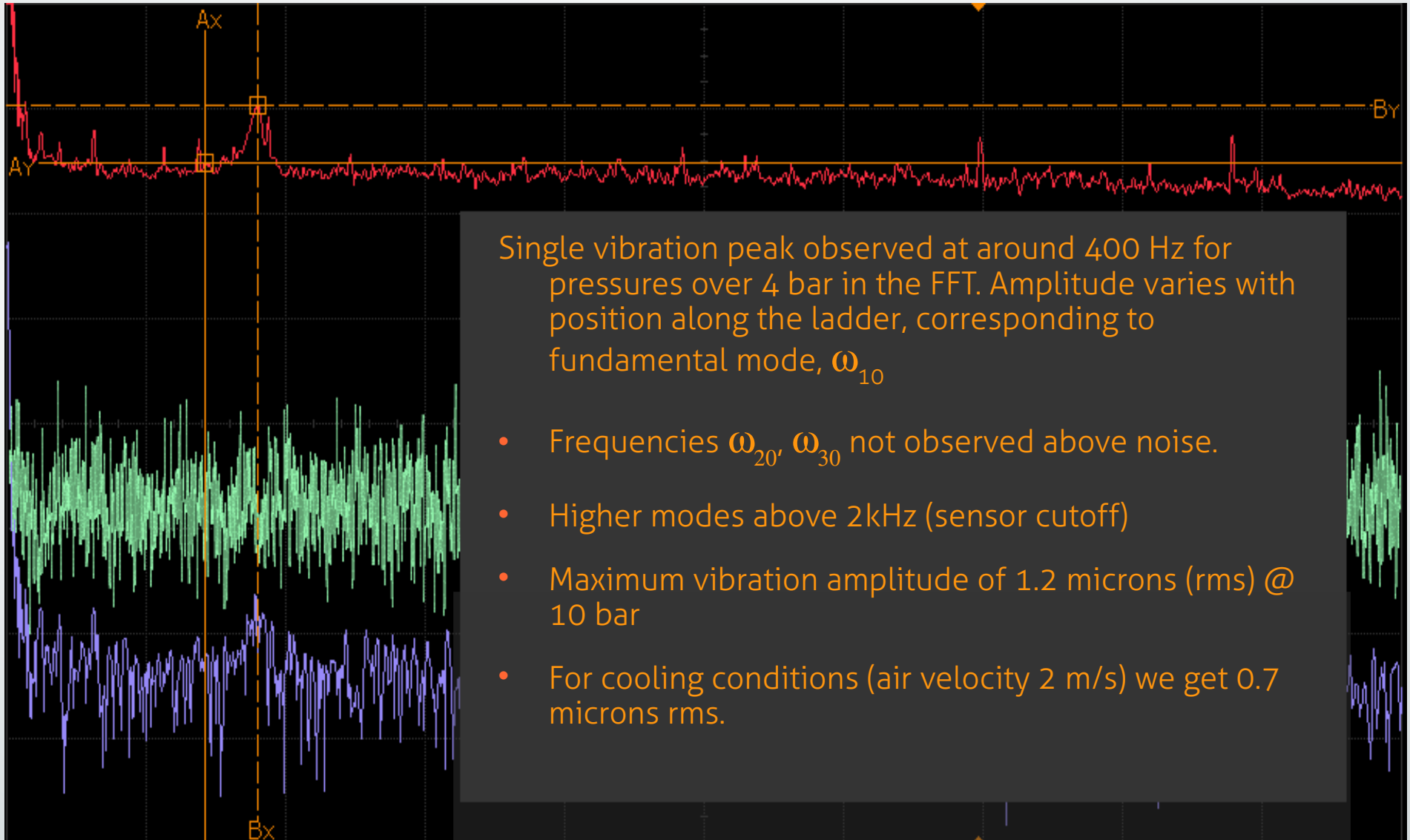
Fundamental mode:  $\omega_{10}$

First few modes:

$$\omega_{20}/\omega_{10}=2, \omega_{30}/\omega_{10}=3 \dots \omega_{n0}/\omega_{10}=n$$

$$\omega_{11}/\omega_{10} \sim 9,1$$

# Vibration studies



Single vibration peak observed at around 400 Hz for pressures over 4 bar in the FFT. Amplitude varies with position along the ladder, corresponding to fundamental mode,  $\omega_{10}$

- Frequencies  $\omega_{20}$ ,  $\omega_{30}$  not observed above noise.
- Higher modes above 2kHz (sensor cutoff)
- Maximum vibration amplitude of 1.2 microns (rms) @ 10 bar
- For cooling conditions (air velocity 2 m/s) we get 0.7 microns rms.



# More info

- Thermomechanical characterization of the Belle II Pixel detector (PXD)
  - <http://digital.csic.es/handle/10261/64311>